Tyrone Camarero Specifications



Camarero DS300TP-212R-SIOM

Key features

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual socket R (LGA 2011) supports Intel® Xeon® processor E5-2600v4/v3 family
- Intel® C612 chipset
- Up to 2TB ECC 3DS LRDIMM, up to DDR4- 2400 MHz; 16x DIMM slots
- 1 PCI-E 3.0 x16 (LP), 1 PCI-E 3.0 x8 (LP), 1 SIOM card support
- 1 Dedicated IPMI LAN port
- 3 Hot-swap 3.5" SATA HDD Bays
- 2000W Redundant Power Supplies Titanium Level (96%)
- 1 SATA DOM





Processor/Cache

Processor Dual socket R (LGA 2011) supports

Intel® Xeon® processor E5-2600

v4/v3 family

Chipset

Chipset Intel® C612 chipset

System Memory

Memory Capacity 16x 288-pin DDR4 DIMM slots,

Up to 2TB ECC 3DS LRDIMM,

512 ECC RDIMM

Expansion Slots

PCI-Express 1 PCI-E 3.0 (x16) Low-profile slot,

1 PCI-E 3.0 (x8) Low-profile slot,

1 SIOM card support

Integrated On-Board

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10

LAN 1 RJ45 Dedicated IPMI LAN port

Add-on Options

Raid Optional

Optical Drive None

Front Panel

LED Indicators Power status LED,HDD activity LED,2x

Network activity LEDs, Universal

Information (UID) LED

Buttons Power On/Off button, UID button

Drive Bays

HDD bays 3x 3.5" Hot-swap SATA HDD trays

Power Supply

2000W Redundant Power Supplies Titanium Level (96%)

Cooling System

4x 8cm heavy duty PWM fans with optimal fan speed control

Form Factor

Form Factor 2U Rackmount

 Height
 :
 3.47"(88mm),

 Width
 :
 17.25"(438mm),

 Depth
 :
 30.5" (774mm)

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For more/current product information, visit www.tyronesystems.com

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